

Product Change Notification

The information below reflects a change that is being implemented.

Notice Date: 03/19/2007

Product Category: Linear Devices; Mixed Signal Devices; Power Management; Thermal Management; LIN Communication; Serial Communication; PIC12xxx; PIC16xxx; PIC17xxx; PIC18xxx; rfPIC

Notification Subject: CCB#725: Qualification of SAC305 Alloy Solder Dipping for CERDIPs at MMT

Notification Body:

Microchip Part#s Affected:

TC7650
TC7652
TC14433
TC14433A
TC850
TC7106
TC7106A
TC7107
TC7107A
TC7116
TC7116A
TC7117
TC7117A
TC500
TC500A
TC7109
TC7109A
TC9400
TC9400EJD
TC9401
TC9402
TC1044S
TC7660
TC7660S
TC7662A
TC962
TC426
TC427
TC428
TC429
TC4403

TC4404
TC4405
TC4420
TC4421
TC4422
TC4423
TC4424
TC4425
TC4426
TC4426A
TC4427
TC4427A
TC4428
TC4428A
TC4429
TC4431
TC4432
TC4467
TC4468
TC4469
TC4626
TC620C
TC620H
MCP201
TC232
PIC12C508
PIC12C508A
PIC12C509
PIC12C509A
PIC12C671
PIC12C672
PIC12CE518
PIC12CE519
PIC12CE673
PIC12CE674
PIC14000
PIC16C432
PIC16C433
PIC16C505
PIC16C52
PIC16C54
PIC16C54A
PIC16C54C
PIC16C55
PIC16C554
PIC16C554A
PIC16C556A
PIC16C557
PIC16C558
PIC16C558A
PIC16C55A
PIC16C56
PIC16C57
PIC16C57C
PIC16C620
PIC16C621

PIC16C621A
PIC16C622
PIC16C622A
PIC16C62A
PIC16C62B
PIC16C63A
PIC16C641
PIC16C64A
PIC16C65A
PIC16C65B
PIC16C66
PIC16C662
PIC16C67
PIC16C71
PIC16C710
PIC16C711
PIC16C712
PIC16C715
PIC16C716
PIC16C717
PIC16C72A
PIC16C73B
PIC16C74A
PIC16C74B
PIC16C76
PIC16C765
PIC16C77
PIC16C771
PIC16C773
PIC16C774
PIC16C781
PIC16CE623
PIC16CE624
PIC16CE625
PIC16CR58A
PIC16F627A
PIC16F628A
PIC16F688-ICD
PIC16F74
PIC16F77
PIC16FR54A
PIC16FR62A
PIC16FR66
PIC16FR710
PIC16FR711
PIC16FR76
PIC16LC505
PIC16LC54A
PIC16LC54C
PIC16LC557
PIC16LC62A
PIC16LC62B
PIC16LC63A
PIC16LC66
PIC16LC710
PIC16LC711

PIC16LC716
PIC16LC717
PIC16LC72A
PIC16LC73B
PIC16LC76
PIC16LC771
PIC16LC773
PIC16LC774
PIC16LC781
PIC16LF627A
PIC16LF628A
PIC16LF74
PIC16LF77
PIC16LFR54A
PIC16LFR62A
PIC16LFR66
PIC16LFR710
PIC16LFR711
PIC16LFR76
PIC16LV54A
PIC17C42A
PIC17C43
PIC17C44
PIC18C242
PIC18C252
PIC18C442
PIC18C452
RFPIC12C509AG
AP7645
AP7675
CF745
CF7645
CF7665
CF7685

Description of Change:
CHANGE BILL OF MATERIAL

Impacts to Data Sheet:
NONE

Reason for Change:
USE OF SAC305 SOLDER MATERIAL FOR CERDIP TERMINATIONS

Estimated Change Implementation Date(s):
MAY 31, 2007

Markings to Distinguish Revised From Unrevised Devices: (e.g.: Date
Code, Device Marking, Ship Container Marking)
TRACEABILITY CODE